

Docket No.

LEE0013-US

## Declaration For Patent Application

### English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

#### Protection Structure Used In Electronic Device With Interchangeable Housing

the specification of which

(check one)

is attached hereto.

was filed on \_\_\_\_\_ as United States Application No. or PCT International Application Number \_\_\_\_\_  
and was amended on \_\_\_\_\_  
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d) or Section 365(b) of any foreign application(s) for patent or inventor's certificate, or Section 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate or PCT International application having a filing date before that of the application on which priority is claimed.

#### Prior Foreign Application(s)

#### Priority Not Claimed

(Number)	Taiwan (Country)	31/7/2002 (Day/Month/Year Filed)	<input type="checkbox"/>
_____	_____	_____	<input type="checkbox"/>
_____	_____	_____	<input type="checkbox"/>

I hereby claim the benefit under 35 U.S.C. Section 119(e) of any United States provisional application(s) listed below:

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(Application Serial No.)

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(Filing Date)

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(Application Serial No.)

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(Filing Date)

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(Application Serial No.)

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(Filing Date)

I hereby claim the benefit under 35 U.S.C. Section 120 of any United States application(s), or Section 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, C. F. R., Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

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(Application Serial No.)

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(Filing Date)

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(Status)

(patent, pending, abandoned)

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(Application Serial No.)

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(Filing Date)

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(Status)

(patent, pending, abandoned)

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(Application Serial No.)

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(Filing Date)

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(Status)

(patent, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor	PAN, Long-Jyh
Sole or first inventor's signature	<i>Pan, Long-Jyh</i>
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Full name of second inventor	CHEN, Hsiao-Wu
Sole or first inventor's signature	<i>Chen, Hsiao-Wu.</i>
Date	2003.7.3
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## Power of Attorney

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**PATENT**

Applicant: PAN, Long-Jyh et al. Docket No.:LEE0013-US

Assignee: BenQ Corporation Group Art Unit: Unknown

Serial No.: New Application Examiner: Unknown

Filed: July 17, 2003

**TITLE:** Protection Structure Used In Electronic Device  
With Interchangeable Housing

**BenQ Corporation** hereby certifies that, to the best of its knowledge and belief, the entire right, title and interest in the above-captioned United States Patent Application is in Assignee.

**BenQ Corporation** with right, title and interest in and to the above-captioned United States patent application and all inventions disclosed and claimed therein, hereby appoints and designates as its Domestic Representative to prosecute this application for patent and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, individually and collectively:

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### BenQ Corporation

By: Sheaffer Lee  
(signature)

Sheaffer Lee  
(typed or printed name)

Executive Vice President  
(typed or printed title)